

In re application of \_\_\_\_\_ : **BOX PATENT APPLICATION**

Yves LE DU et al. : Examiner: Unassigned

Serial No.: Unassigned : Group Art Unit: Unassigned

Filed: March 30, 2001

For: STRUCTURE COMPRISING A BINDER LAYER NON-DELAMINABLE WITH RESPECT TO A METALLIZED SUBSTRATE AND PEELABLE WITH RESPECT TO A POLYPROPYLENE SUBSTRATE

**PRELIMINARY AMENDMENT**

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D.G.  
11-8-01

11-8-01

Assistant Commissioner for Patents  
Washington, D.C. 20231

Washington, D.C. 20231

Sir:

Prior to examination, Applicants wish to amend the above-identified application as indicated below:

**IN THE CLAIMS**

Please amend the claims as follows:

Please cancel claims 1-15 without prejudice or disclaimer.

Please add the following claims:

16. A multilayer structure comprising a metal layer or a metallized-substrate layer (5) and a polypropylene-based binder layer (6) extrusion-coated at a rate of more than 100 m/min. onto the metal or metallized-substrate layer, said layers (6, 5) being made non-delaminable by heat treating the said structure to a temperature above the melting point of the binder layer (6).

17. A structure according to claim 16, wherein the heat treatment is carried out by infrared radiation, by passing it through a hot-air or induction-heating tunnel.